

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Serial No.: **10/829,060** Examiner: **Hoa Cao Nguyen**  
Inventor: **Su-Tsai Lu, Shu-Ming Chang, Shyh-Ming Chang, Yao-Sheng Lin  
and Yuan-Chang Huang**  
Filed: **04/20/2004** Art Unit: **2841**  
Title: **Bonding Structure With Buffer Layer And Method Of Forming The  
Same**

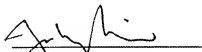
RESPONSE TO ELECTION/RESTRICTION REQUIREMENT

Sir:

In response to the election/restriction requirement in the Office Action dated **05/26/2006**, applicants elect **Specie 1 (Figures 106b and 11a-11b)** which is readable on **claims 1-10 and 14-17** of the invention to prosecute without traverse.

Currently, claim 1 is generic. Applicants also respectfully request consideration of **claims 11-13 and 18-20** drawn to a bonding structure with a buffer layer upon the allowance of the generic claim 1.

Respectfully submitted,



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